Job Annoucement Form

Sandisk

Job Type: Internship
 Job Designation: Firmware Engineer Intern
Job Description: Internship
Cost to Company/ Stipend: 18000
Gross Take Home:
Perks: No
Bond: No
CGPA Cutoff: 7
Programmes Allowed: BE
Trades Allowed (BE): Computer Science,Electronics and Communication,Electrical
Trades Allowed (ME): NA
Selection Procedure: Pre-Placement Talk,Shortlist from Resumes
Written: Both
Interview: In Person
Others: NA
Date of Visit: 2016-05-27
Application deadline: 2016-05-25